

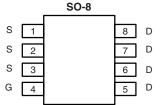
**Vishay Siliconix** 

# N-Channel 30-V (D-S) MOSFET with Schottky Diode

MOSFET PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)				
30	0.016 at V <sub>GS</sub> = 10 V	9.5				
	0.021 at V <sub>GS</sub> = 4.5 V	7.7				

#### SCHOTTKY PRODUCT SUMMARY

V <sub>DS</sub> (V)	V <sub>SD</sub> (V) Diode Forward Voltage	I <sub>F</sub> (A)
30	0.50 V at 1.0 A	1.4



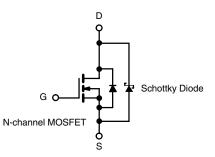
Top View

Ordering Information: Si4812BDY-T1-E3 (Lead (Pb)-free) Si4812BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- LITTLE FOOT<sup>®</sup> Plus Power MOSFET
- 100 % R<sub>g</sub> Tested ٠





ABSOLUTE MAXIMUM RATINGS	T <sub>A</sub> = 25 °C, unle	ss otherwise	noted		
			Limit		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage (MOSFET)		V <sub>DS</sub>	30		
Reverse Voltage (Schottky)		V DS	30		V
Gate-Source Voltage (MOSFET)		V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C) (MOSFET	<sub>г)</sub> а, b Т <sub>А</sub> = 25 °С	I <sub>D</sub>	9.5	7.3	
Continuous Drain Current ( $T_{j} = 150^{\circ}$ C) (MOSFE)	$T_{A} = 70 ^{\circ}C$	U	7.7	5.9	
Pulsed Drain Current (MOSFET)		I <sub>DM</sub>	50		A
Continuous Source Current (MOSFET Diode Conduction) <sup>a, b</sup>		۱ <sub>S</sub>	2.1	1.2	
Average Forward Current (Schottky)		۱ <sub>F</sub>	1.4	0.8	
Pulsed Forward Current (Schottky)		I <sub>FM</sub>	30		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	5 1.25		
Avalanche Energy		E <sub>AS</sub>			mJ
Maximum Power Dissipation (MOSFET) <sup>a, b</sup>	T <sub>A</sub> = 25 °C		2.5	1.4	w
Maximum Power Dissipation (MOSPET)	T <sub>A</sub> = 70 °C	P <sub>D</sub>	1.6	0.9	
Maximum Dawar Dissinction (Cabattle Va. b	T <sub>A</sub> = 25 °C	· U	2.0	1.2	
Maximum Power Dissipation (Schottky) <sup>a, b</sup>	T <sub>A</sub> = 70 °C	Γ	1.3	0.8	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>stg</sub>	- 55	to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Device	Symbol	Typical	Maximum	Unit	
	MOSFET		40	50	°C/W	
Maximum Junction-to-Ambient (t $\leq$ 10 s) <sup>a</sup>	Schottky	R <sub>thJA</sub>	50	60		
	MOSFET	''thJA	72	90		
Maximum Junction-to-Ambient (t = Steady State) <sup>a</sup>	Schottky	-	85	100		
	MOSFET	R <sub>thJF</sub>	18	23		
Maximum Junction-to-Foot (t = Steady State) <sup>a</sup>	Schottky	nthJF	24	30		

Notes:

a. Surface Mounted on FR4 board. b.  $t \le 10$  s.

# Si4812BDY

#### Vishay Siliconix

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		0.004	0.100		
Zero Gate Voltage Drain Current (MOSFET and Schottky)	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$		0.7	10	mA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		3.0	20		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	20			А	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		0.013	0.016	0	
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7.7 \text{ A}$		0.0165	0.021	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 9.5 \text{ A}$		45		S	
	V	I <sub>S</sub> = 1.0 A, V <sub>GS</sub> = 0 V	I <sub>S</sub> = 1.0 A, V <sub>GS</sub> = 0 V		0.50		
Schottky Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{\rm S}$ = 1.0 A, $V_{\rm GS}$ = 0 V, $T_{\rm J}$ = 125 °C		0.33	0.42	V	
Dynamic <sup>b</sup>			•	•			
Total Gate Charge	Qg			8.5	13		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 9.5 \text{ A}$		3		nC	
Gate-Drain Charge	Q <sub>gd</sub>			2.6			
Gate Resistance	Rg		0.3	0.7	1.1	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	25		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		13	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$t_{d(off)} \qquad \qquad I_{D} \cong 1 \text{ A},  \text{V}_{\text{GEN}} = 10 \text{ V},  \text{R}_{g} = 6  \Omega$		20	30	ns	
Fall Time	t <sub>f</sub>			8	15		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1.0 A, dl/dt = 100 A/μs		22	35		

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

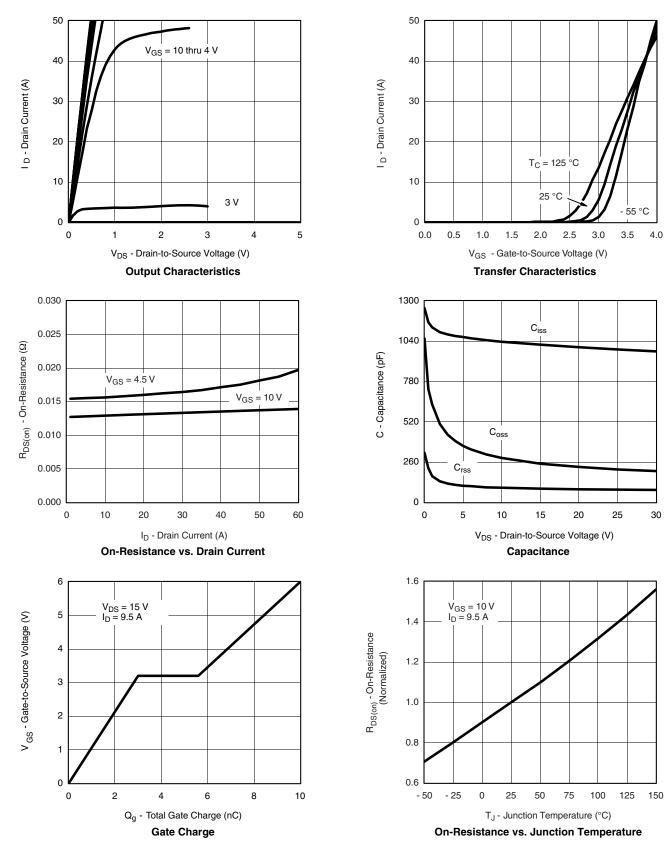
VISHA



# Si4812BDY

Vishay Siliconix

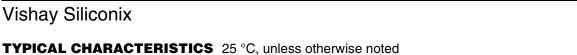
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



# Si4812BDY

#### **Vishay Siliconix**

50

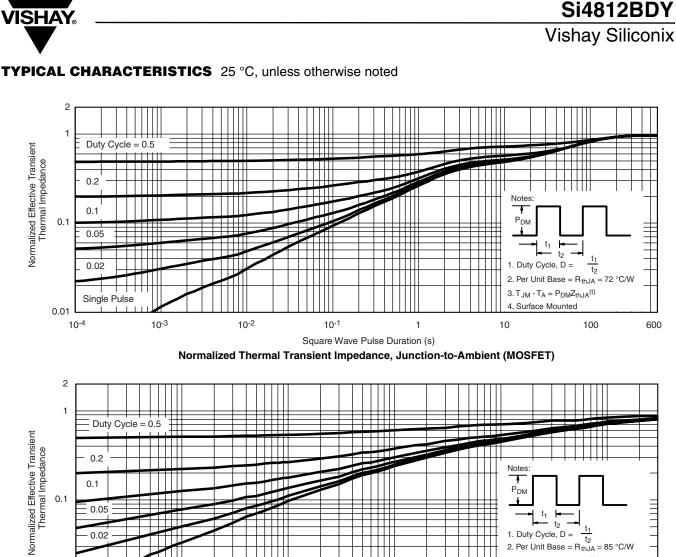


0.05

VISHAY

#### T<sub>J</sub> = 150 °C 0.04 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance ( $\Omega)$ 10 I S - Source Current (A) I<sub>D</sub> = 9.5 A 0.03 T<sub>J</sub> = 25 °C 0.02 1 0.01 0.00 0.1 0.0 0.2 0.4 0.6 0.8 1.0 1.2 2 4 6 8 0 10 V<sub>SD</sub> - Source-to-Drain Voltage (V) V<sub>GS</sub> - Gate-to-Source Voltage (V) Source-Drain Diode Forward Voltage On-Resistance vs. Gate-to-Source Voltage 50 10 40 1 I R - Reverse Current (mA) 0.1 30 V Power (W) 30 0.01 20 0.001 20 V 10 0.0001 10 V 0 0.00001 0 25 50 75 100 125 150 0.01 0.1 10 600 1 100 T<sub>J</sub> - Junction Temperature (°C) Time (s) **Reverse Current (Schottky)** Single Pulse Power (MOSFET) 100 Limited b R<sub>DS(c</sub> 10 I<sub>D</sub> - Drain Current (A) ms 10 ms 100 m S 0.1 $T_C = 25 \ ^{\circ}C$ Single Pulse 0.5 DC 0.01 0.1 10 100 1 V<sub>DS</sub> - Drain-to-Source Voltage (V) \* $V_{GS}$ > minimum $V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Case



3.  $T_{JM}$  -  $T_A = P_{DM}Z_{thJA}^{(t)}$ Single Pulse 4. Surface Mounted 1 1 1 1 1 1 0.01 10<sup>-3</sup> 10-4 10-2 10-1 1 10 Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient (Schottky)

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73038.

0.02

t<sub>2</sub>

1. Duty Cycle, D =

t<sub>1</sub>

t2 2. Per Unit Base = R<sub>thJA</sub> = 85 °C/W

30



# Package Information

Vishay Siliconix

#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





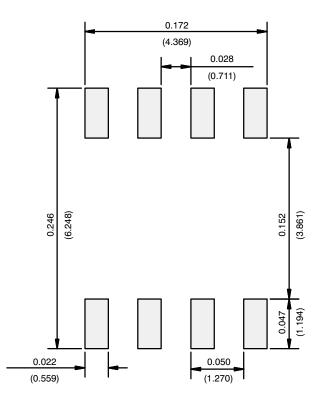
	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

#### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.



单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)

>>点击查看相关商品